



Barry Announces their new Semiconductor Packaging Division: Semiconductor Enclosures, Inc.



January 2008 - Newburyport, MA - Barry Industries announces their new division featuring semiconductor packaging. Located in Newburyport, Massachusetts, this division manufactures ceramic packages and components for Aerospace, RF/Microwave, Semiconductor, and Optoelectronic Devices.

Products include Microwave Diodes/Varactors, GaAs FETs, MMICs, Power Semiconductors, RF Bipolar Transistors, and more.

In addition to Barry's new semiconductor packaging division, Barry provides a full line of Power and Precision Thick Film resistors, terminations and attenuators on Alumina, BeO, BeO FreeTM and Aluminum Nitride for your microwave and RF applications.

Barry also has an LTCC multilayer foundry, design and production facility for products to 65 GHz. High Power Ceramic Packages, Machining and Electroplating – a vertically integrated company.

For further information, please contact chrism@semiconductorenclosures.com